

FEATURES

- Improved Direct Replacement for AD7543 and DAC-8143
- Low Cost
- DNL and INL Over Temperature: $\pm 0.5\text{ LSB}$
- Easy, Fast and Flexible Serial Interface
- Daisy-Chain 3-Wire Interface for Multiple DAC Systems (LTC8143)
- 1LSB Maximum Gain Error Over Temperature Eliminates Adjustment
- Asynchronous Clear Input for Initialization
- Four-Quadrant Multiplication
- Low Power Consumption
- 16-Pin PDIP and SO Packages

APPLICATIONS

- Process Control and Industrial Automation
- Remote Microprocessor-Controlled Systems
- Digitally Controlled Filters and Power Supplies
- Programmable Gain Amplifiers
- Automatic Test Equipment

DESCRIPTION

The LTC®7543/LTC8143 are serial-input 12-bit multiplying digital-to-analog converters (DACs). They are superior pin compatible replacements for the AD7543 and DAC-8143. Improvements include better accuracy, better stability over temperature and supply variations, lower sensitivity to output amplifier offset, tighter timing specifications and lower output capacitance.

An easy-to-use serial interface includes an asynchronous CLEAR input for systems requiring initialization to a known state. The LTC8143 has a serial data output to allow daisy-chaining multiple DACs on a 3-wire interface bus.

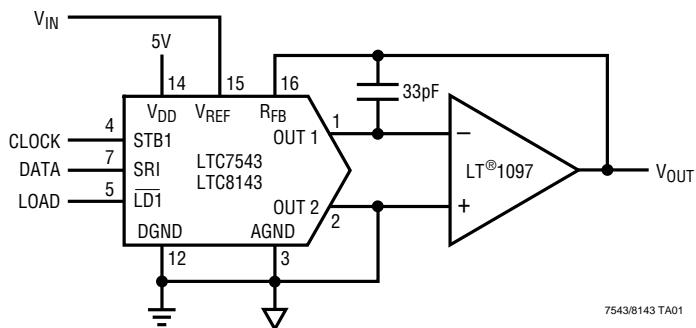
These DACs are extremely versatile. They can be used for 2-quadrant and 4-quadrant multiplying, programmable gain and single supply applications, such as noninverting voltage output and biased or offset ground mode.

Parts are available in 16-pin PDIP and SO packages and are specified over the extended industrial temperature range, -40°C to 85°C .

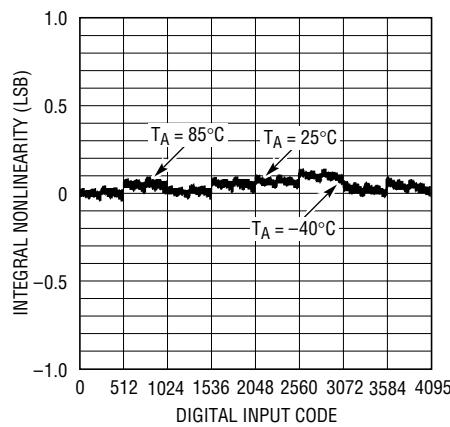
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TYPICAL APPLICATION

Multiplying DAC Has Easy 3-Wire Serial Interface



Integral Nonlinearity Over Temperature



LTC7543/LTC8143

ABSOLUTE MAXIMUM RATINGS

V_{DD} to AGND	-0.5V to 7V
V_{DD} to DGND	-0.5V to 7V
AGND to DGND	$V_{DD} + 0.5V$
DGND to AGND	$V_{DD} + 0.5V$
Digital Inputs to DGND	-0.5V to ($V_{DD} + 0.5V$)
V_{OUT1}, V_{OUT2} to AGND	-0.5V to ($V_{DD} + 0.5V$)
V_{REF} to AGND, DGND	$\pm 25V$
V_{RFB} to AGND, DGND	$\pm 25V$
Maximum Junction Temperature	150°C
Operating Temperature Range	-40°C to 85°C
Storage Temperature Range	-65°C to 150°C
Lead Temperature (Soldering, 10 sec)	300°C

PACKAGE/ORDER INFORMATION

TOP VIEW		ORDER PART NUMBER
OUT 1	1	16 R _{FB}
OUT 2	2	15 V _{REF}
AGND	3	14 V _{DD}
STB1	4	13 CLR
LD1	5	12 DGND
NC (LTC7543) SRO (LTC8143)	6	11 STB4
SRI	7	10 STB3
STB2	8	9 LD2
		N PACKAGE 16-LEAD PDIP
		SW PACKAGE 16-LEAD PLASTIC SO WIDE
		$T_{JMAX} = 150^\circ\text{C}$, $\theta_{JA} = 100^\circ\text{C}/\text{W}$ (N) $T_{JMAX} = 150^\circ\text{C}$, $\theta_{JA} = 130^\circ\text{C}/\text{W}$ (SW)

Consult factory for Military grade parts.

ACCURACY CHARACTERISTICS – LTC7543

$V_{DD} = 5V$, $V_{REF} = 10V$, $V_{OUT1} = V_{OUT2} = \text{AGND} = \text{DGND} = 0V$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	LTC7543GK			LTC7543K			UNITS
			MIN	TYP	MAX	MIN	TYP	MAX	
	Resolution		●	12		12			Bits
INL	Integral Nonlinearity (Relative Accuracy)	(Note 1)	●		± 0.5			± 0.5	LSB
DNL	Differential Nonlinearity	Guaranteed Monotonic, T_{MIN} to T_{MAX}	●		± 0.5			± 0.5	LSB
GE	Gain Error	(Note 2) $T_A = 25^\circ\text{C}$ T_{MIN} to T_{MAX}	●		± 1 ± 1			± 2 ± 2	LSB
	Gain Temperature Coefficient (Δ Gain/ Δ Temp)	(Note 3)	●	1	5	1	5		ppm/ $^\circ\text{C}$
I _{LKG}	Output Leakage Current	(Note 4) $T_A = 25^\circ\text{C}$ T_{MIN} to T_{MAX}	●		± 1 ± 10			± 1 ± 10	nA
	Zero-Scale Error				± 0.006 ± 0.06			± 0.006 ± 0.06	LSB
PSRR	Power Supply Rejection Ratio	$V_{DD} = 5V \pm 5\%$	●	± 0.0001	± 0.002	± 0.0001	± 0.002		%/%

ACCURACY CHARACTERISTICS – LTC8143 $V_{DD} = 5V$, $V_{REF} = 10V$, $V_{OUT1} = V_{OUT2} = AGND = DGND = 0V$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	LTC8143E			LTC8143F			UNITS
			MIN	TYP	MAX	MIN	TYP	MAX	
	Resolution		●	12		12			Bits
INL	Integral Nonlinearity (Relative Accuracy)	(Note 1)	●		±0.5			±1	LSB
DNL	Differential Nonlinearity	Guaranteed Monotonic, T_{MIN} to T_{MAX}	●		±0.5			±1	LSB
GE	Gain Error	(Note 2) $T_A = 25^\circ C$ T_{MIN} to T_{MAX}	●		±1 ±2			±2 ±2	LSB LSB
	Gain Temperature Coefficient (Δ Gain/ Δ Temp)	(Note 3)	●	1	5	1	5		ppm/ $^\circ C$
I_{LKG}	Output Leakage Current	(Note 4) $T_A = 25^\circ C$ T_{MIN} to T_{MAX}	●		±5 ±25			±5 ±25	nA nA
	Zero-Scale Error		●		±0.03 ±0.15			±0.03 ±0.15	LSB LSB
PSRR	Power Supply Rejection Ratio	$V_{DD} = 5V \pm 5\%$	●	±0.0001	±0.002	±0.0001	±0.002		%/%

ELECTRICAL CHARACTERISTICS – LTC7543/LTC8143 $V_{DD} = 5V$, $V_{REF} = 10V$, $V_{OUT1} = V_{OUT2} = AGND = DGND = 0V$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	LTC7543/LTC8143 ALL GRADES			UNITS	
			MIN	TYP	MAX		
Reference Input							
R_{REF}	V_{REF} Input Resistance	(Note 5)	●	8	11	15	
AC Performance (Note 3)							
	Output Current Settling Time	(Notes 6, 7)	●	0.25	1	μs	
	Multiplying Feedthrough Error	$V_{REF} = \pm 10V$, 10kHz Sinewave	●	0.8	2	mV _{P-P}	
	Digital-to-Analog Glitch Energy	(Notes 6, 8)	●	2	20	nV-sec	
THD	Total Harmonic Distortion	(Note 9)	●	-108	-92	dB	
	Output Noise Voltage Density	(Note 10)	●		13	nV/ \sqrt{Hz}	
Analog Outputs (Note 3)							
C_{OUT}	Output Capacitance	DAC Register Loaded to All 1s	C_{OUT1}	●	60	90	pF
			C_{OUT2}	●	20	60	pF
		DAC Register Loaded to All 0s	C_{OUT1}	●	30	60	pF
			C_{OUT2}	●	50	90	pF
Digital Inputs							
V_{IH}	Digital Input High Voltage		●	2.4		V	
V_{IL}	Digital Input Low Voltage		●		0.8	V	
I_{IN}	Digital Input Current	$V_{IN} = 0V$ to V_{DD}	●	0.001	±1	μA	
C_{IN}	Digital Input Capacitance	(Note 3), $V_{IN} = 0V$	●		8	pF	
Digital Outputs: SRO (LTC8143 Only)							
V_{OH}	Digital Output High	$I_{OH} = -200\mu A$	●	4		V	
V_{OL}	Digital Output Low	$I_{OL} = 1.6mA$	●		0.4	V	

LTC7543/LTC8143

ELECTRICAL CHARACTERISTICS – LTC7543/LTC8143

$V_{DD} = 5V$, $V_{REF} = 10V$, $V_{OUT1} = V_{OUT2} = AGND = DGND = 0V$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	LTC7543/LTC8143 ALL GRADES			UNITS	
			MIN	TYP	MAX		
Timing Characteristics (Note 3)							
t_{DS1}	Serial Input to Strobe Setup Time ($t_{STB} = 80ns$)	STB1 Used as the Strobe	●	50	5	ns	
t_{DS2}		STB2 Used as the Strobe	●	20	-5	ns	
t_{DS3}		STB3 Used as the Strobe	●	0	-30	ns	
t_{DS4}		STB4 Used as the Strobe	●	0	-30	ns	
t_{DH1}	Serial Input to Strobe Hold Time ($t_{STB} = 80ns$)	STB1 Used as the Strobe	●	30	10	ns	
t_{DH2}		STB2 Used as the Strobe	●	50	25	ns	
t_{DH3}		STB3 Used as the Strobe	●	80	55	ns	
t_{DH4}		STB4 Used as the Strobe	●	80	55	ns	
t_{SRI}	Serial Input Data Pulse Width		●	80		ns	
$t_{STB1}, t_{STB2},$ t_{STB3}, t_{STB4}	Strobe Pulse Width	(Note 11)	●	80		ns	
$\overline{t_{STB1}}, \overline{t_{STB2}},$ $\overline{t_{STB3}}, \overline{t_{STB4}}$	Strobe Pulse Width	(Note 12)	●	80		ns	
t_{LD1}, t_{LD2}	Load Pulse Width		●	140		ns	
t_{ASB}	LSB Strobed into Input Register to Load DAC Register Time		●	0		ns	
t_{CLR}	Clear Pulse Width		●	80		ns	
SRO Timing Characteristics (LTC8143 Only)							
t_{PD}	STB2, STB3, STB4 Strobe to SRO Propagation Delay	$C_L = 50pF$	●	220	120	ns	
t_{PD1}	STB1 to SRO Propagation Delay	$C_L = 50pF$	●	150	80	ns	
Power Supply							
V_{DD}	Supply Voltage		●	4.75	5	5.25	V
I_{DD}	Supply Current	Digital Inputs = 0V or V_{DD} Digital Inputs = V_{IH} or V_{IL}	●		0.1	mA	
			●		2	mA	

The ● denotes specifications which apply over the full operating temperature range.

Note 1: $\pm 0.5LSB = \pm 0.012\%$ of full scale.

Note 2: Using internal feedback resistor.

Note 3: Guaranteed by design, not subject to test.

Note 4: I_{OUT1} with DAC register loaded with all 0s or I_{OUT2} with DAC register loaded with all 1s.

Note 5: Typical temperature coefficient is 100ppm/ $^{\circ}C$.

Note 6: OUT 1 load = 100Ω in parallel with 13pF.

Note 7: To 0.01% for a full-scale change, measured from falling edge of LD1 or LD2.

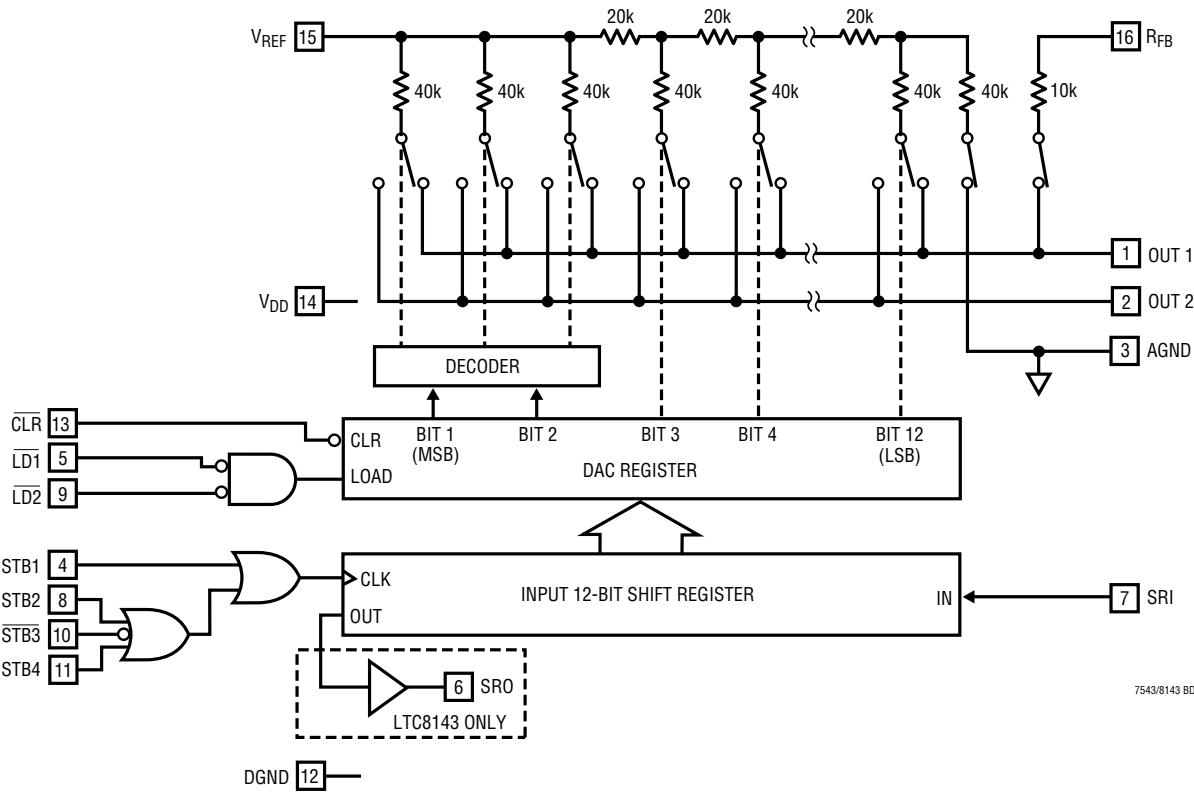
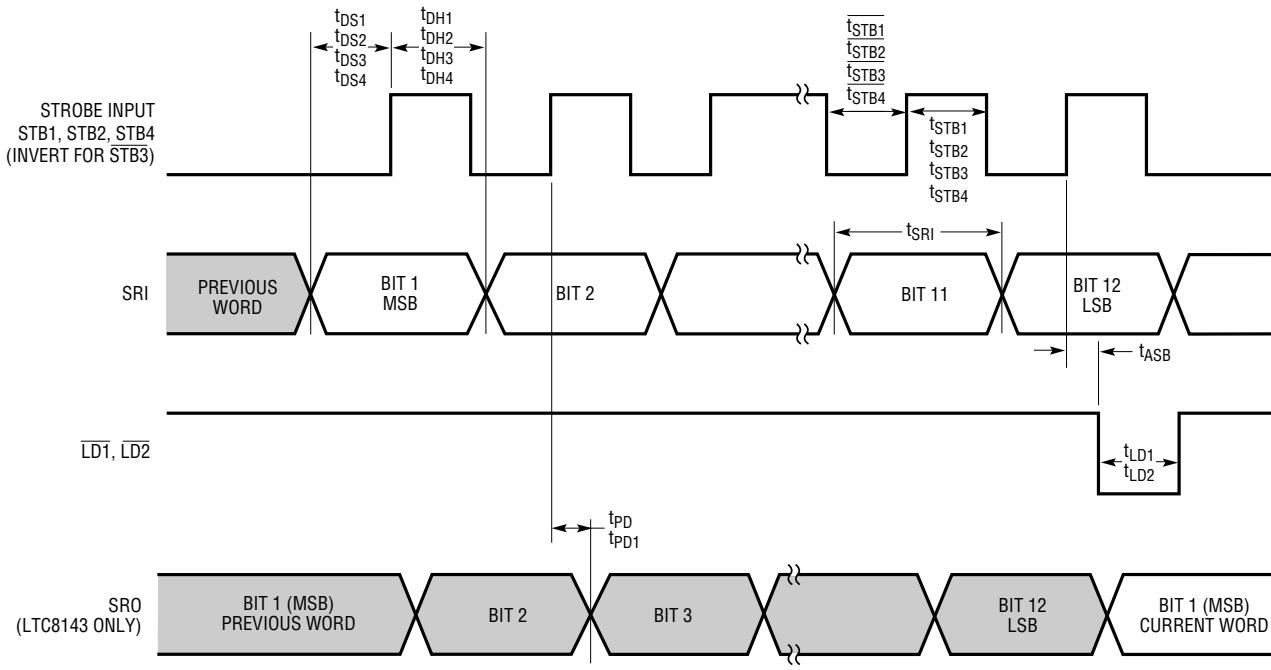
Note 8: $V_{REF} = 0V$. DAC register contents changed from all 0s to all 1s or from all 1s to all 0s.

Note 9: $V_{REF} = 6V_{RMS}$ at 1kHz. DAC register loaded with all 1s.

Note 10: Calculation from $e_n = \sqrt{4KTRB}$ where: K = Boltzmann constant (J/K°); R = resistance (Ω); T = resistor temperature ($^{\circ}K$); B = bandwidth (Hz).

Note 11: Minimum high time for STB1, STB2, STB4. Minimum low time for STB3.

Note 12: Minimum low time for STB1, STB2, STB4. Minimum high time for STB3.

BLOCK DIAGRAM**TIMING DIAGRAM**

7543/8143 TD01

LTC7543/LTC8143

TRUTH TABLES

Table 1. LTC7543/LTC8143 Input Register

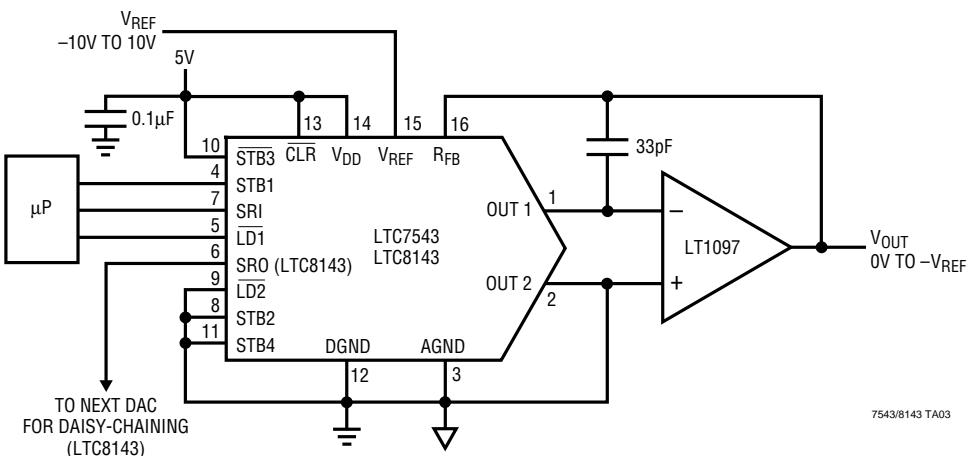
CONTROL INPUTS				Input Register Operation (LTC8143: SRO Operation)
STB1	STB2	STB3	STB4	
0	1	0		Serial Data Bit on SRI Loaded into Input Register, MSB First
0	1	0		(LTC8143: Data Bit or SRI Appears on SRO Pin After 12 Clocked Bits)
1	X	X	X	No Input Register Operation (LTC8143: No SRO Operation)
X	1	X	X	
X	X	0	X	
X	X	X	1	

Table 2. LTC7543/LTC8143 DAC Register

CONTROL INPUTS			DAC Register Operation
CLR	LD1	LD2	
0	X	X	Reset DAC Register to All 0s (Asynchronous Operation; No Effect on Input Register)
1	1	X	No DAC Register Operation
1	X	1	
1	0	0	Load DAC Register with the Contents of Input Register

TYPICAL APPLICATIONS

Unipolar Operation (2-Quadrant Multiplication)

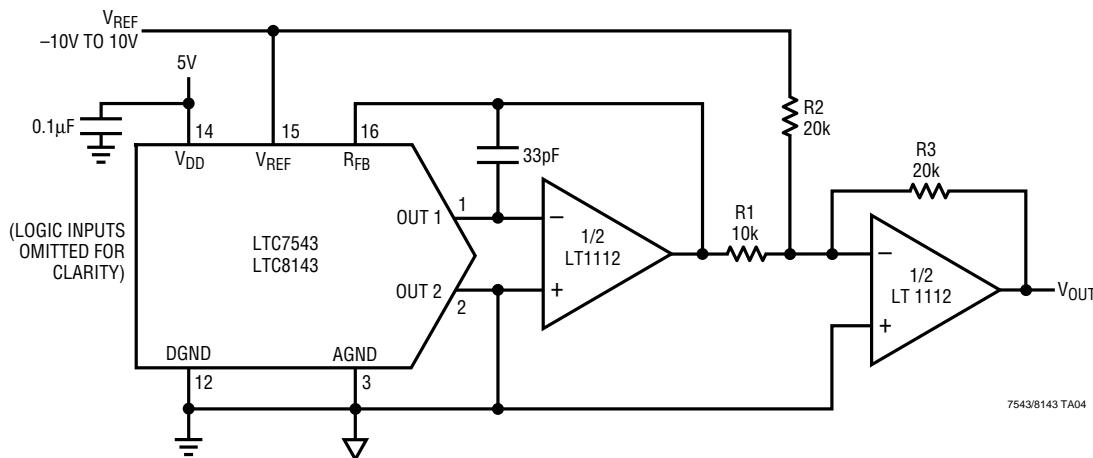


Unipolar Binary Code Table

DIGITAL INPUT BINARY NUMBER IN DAC REGISTER			ANALOG OUTPUT V _{OUT}
MSB	LSB		
1111	1111	1111	-V _{REF} (4095/4096)
1000	0000	0000	-V _{REF} (2048/4096) = -V _{REF} /2
0000	0000	0001	-V _{REF} (1/4096)
0000	0000	0000	0V

TYPICAL APPLICATIONS

Bipolar Operation (4-Quadrant Multiplication)



7543/8143 TA04

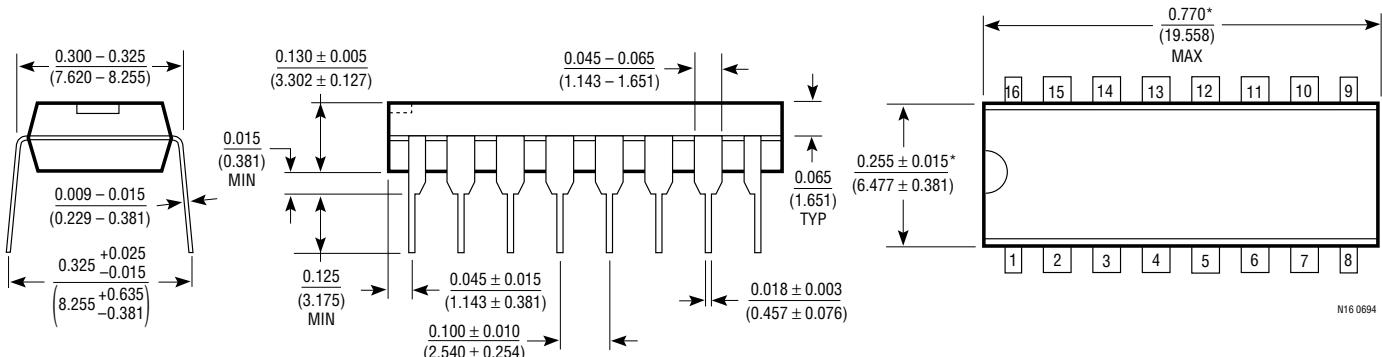
Bipolar Offset Binary Code Table

DIGITAL INPUT BINARY NUMBER IN DAC REGISTER			ANALOG OUTPUT V_{OUT}
MSB	LSB		
1111	1111	1111	$V_{REF} (2047/2048)$
1000	0000	0001	$V_{REF} (1/2048)$
1000	0000	0000	0V
0111	1111	1111	$-V_{REF} (1/2048)$
0000	0000	0000	$-V_{REF} (2048/2048) = -V_{REF}$

PACKAGE DESCRIPTION

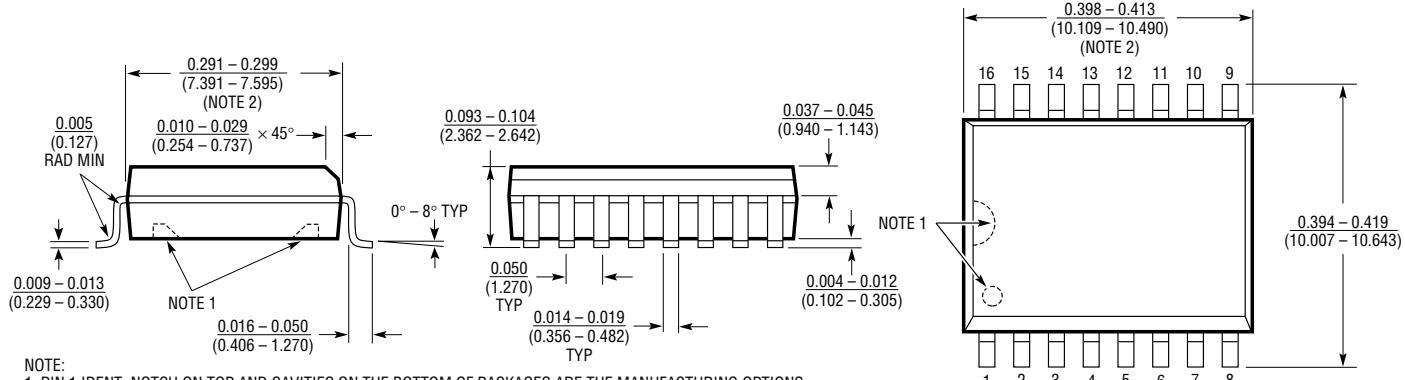
Dimension in inches (millimeters) unless otherwise noted.

**N Package
16-Lead Plastic DIP**



*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
MOLD FLASH OR PROTURSIONS SHALL NOT EXCEED 0.010 INCH (0.254mm).

**S Package
16-Lead Plastic SOL**



NOTE:

- PIN 1 IDENT, NOTCH ON TOP AND CAVITIES ON THE BOTTOM OF PACKAGES ARE THE MANUFACTURING OPTIONS.
THE PART MAY BE SUPPLIED WITH OR WITHOUT ANY OF THE OPTIONS.
- THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
MOLD FLASH OR PROTURSIONS SHALL NOT EXCEED 0.006 INCH (0.15mm).

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LTC1257	Complete Serial I/O V _{OUT} 12-Bit DAC	5V to 15V Single Supply in 8-Pin SO and PDIP
LTC1451/LTC1452/LTC1453	Complete Serial I/O V _{OUT} 12-Bit DACs	3V/5V Single Supply in 8-Pin SO and PDIP
LTC7541A	Parallel I/O Multiplying 12-Bit DAC	12-Bit Wide Input
LTC8043	Serial Multiplying 12-Bit DAC	8-Pin SO and PDIP